1-917361-0 - ACTIVE

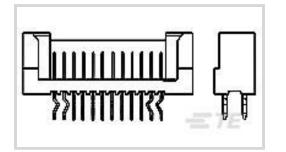
AMPMODU | AMPMODU 2 mm

TE Internal #: 1-917361-0 PCB Mount Header, Vertical, Board-to-Board, 10 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **10**

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Vertical
Number of Positions	10
Number of Rows	1
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	100 MΩ
Operating Voltage	50 VAC
Body Features	
Primary Product Color	White
Contact Features	
Contact Layout	Inline
Mating Tab Width	1.6 mm[.063 in]

PCB Mount Header, Vertical, Board-to-Board, 10 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



Mating Tab Thickness	.25 mm[.01 in]
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]
Contact Type	Tab
Contact Current Rating (Max)	1 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Rectangular Termination Post & Tail Width	.6 mm[.024 in]
Termination Post & Tail Length	3.2 mm[.126 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention Type	Kinked Legs
Mating Alignment	With
Mating Alignment Type	Self-Aligning (Alignment Free)
PCB Mount Retention	With
PCB Mount Alignment	With

Board Mount

Housing Features

Mating Entry Location	Тор
Centerline (Pitch)	1.25 mm[.049 in]
Housing Material	Nylon 6/6 GF
Dimensions	
Connector Height	7.8 mm[.307 in]
Row-to-Row Spacing	2.5 mm[.098 in]
PCB Thickness (Recommended)	1.6 mm[.062 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0

PCB Mount Header, Vertical, Board-to-Board, 10 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



Packaging Features

Packaging Quantity	414
Packaging Type	Box, Tray
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2017 (173) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

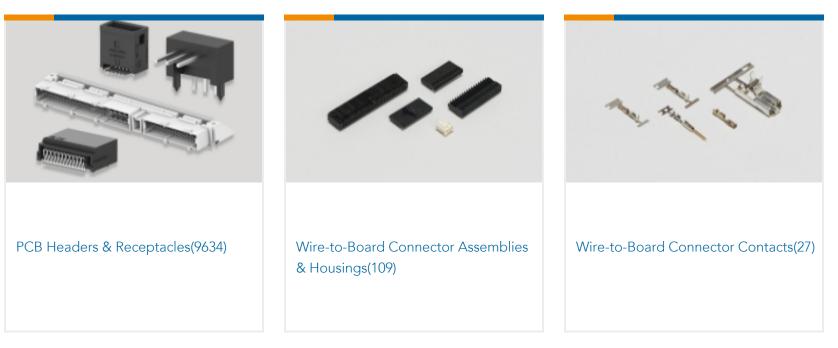
Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 10 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm





Also in the Series | AMPMODU 2 mm



Documents

Product Drawings 1.25 AF TAB ASY 10P TOP ENTRY

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-917361-0_C.2d_dxf.zip

English

3D PDF

3D

Customer View Model ENG_CVM_CVM_1-917361-0_C.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_1-917361-0_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Product Specifications

Product Specification

Japanese

Crimping Multi-Interlock Connector Contacts

Japanese

Agency Approvals

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 10 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



Agency Approval Document

English